

# Hyperfast Rectifier, 30 A FRED Pt® G5



#### **LINKS TO ADDITIONAL RESOURCES**





PRIMARY CHARACTERISTICS									
I <sub>F(AV)</sub>	30 A								
V <sub>R</sub>	600 V								
V <sub>F</sub> at I <sub>F</sub> at 125 °C	1.15 V								
t <sub>rr</sub> (typ.)	25 ns								
T <sub>J</sub> max.	175 °C								
Package	TO-220AC 2L								
Circuit configuration	Single								

#### **FEATURES**

 Best in class forward voltage drop and switching losses trade off



- Optimized for high speed operation
- 175 °C maximum operating junction temperature
- Polyimide passivation
- Meets JESD 201 class 1A whisker test
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>

#### **DESCRIPTION / APPLICATIONS**

Featuring a unique combination of low conduction and switching losses, this rectifier is the right choice for soft switched and resonant converters, as well as medium frequency hard switching converters. This device is specifically designed to improve efficiency of high speed LLC output rectification stages of EV / HEV battery charging stations and high frequency stages of UPS applications.

#### **MECHANICAL DATA**

Case: TO-220AC 2L

Molding compound meets UL 94 V-0 flammability rating

Terminals: matte tin plated leads, solderable per

J-STD-002

ABSOLUTE MAXIMUM RATINGS										
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS						
Repetitive peak reverse voltage	$V_{RRM}$		600	V						
Average rectified forward current	I <sub>F(AV)</sub>	T <sub>C</sub> = 113 °C, D = 0.50	30	Α						
Repetitive peak forward current	I <sub>FRM</sub>	T <sub>C</sub> = 113 °C, D = 0.50, f = 20 kHz	60							
Non-repetitive peak surge current	I <sub>FSM</sub>	$T_C = 25$ °C, $t_p = 10$ ms, sine wave	330							
Operating junction and storage temperature	T <sub>J</sub> , T <sub>Stg</sub>		-55 to +175	°C						

<b>ELECTRICAL SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C unless otherwise specified)										
PARAMETER SYMBOL TEST CONDITIONS MIN. TYP. MAX. U										
Breakdown voltage, blocking voltage	$V_{BR}, V_{R}$	I <sub>R</sub> = 100 μA	600	-	-					
Famous valtage	W	I <sub>F</sub> = 30 A	-	1.3	1.6	V				
Forward voltage	V <sub>F</sub>	I <sub>F</sub> = 30 A, T <sub>J</sub> = 125 °C	-	1.15	-					
Payaraa laakaga ayrrant		V <sub>R</sub> = V <sub>R</sub> rated	-	-	20					
Reverse leakage current	IR	T <sub>J</sub> = 125 °C, V <sub>R</sub> = V <sub>R</sub> rated	-	-	500	μA				
Junction capacitance	C <sub>T</sub>	V <sub>R</sub> = 200 V	-	36	-	pF				
Series inductance	L <sub>S</sub>	Measured to lead 5 mm from package body	-	8	-	nH				



<b>DYNAMIC RECOVERY CHARACTERISTICS</b> (T <sub>J</sub> = 25 °C unless otherwise specified)										
PARAMETER	SYMBOL	TEST CO	NDITIONS	MIN.	TYP.	MAX.	UNITS			
		$I_F = 1.0 A, dI_F/dt =$	=	25	-					
Reverse recovery time	t <sub>rr</sub>	T <sub>J</sub> = 25 °C		1	41	-	ns			
		T <sub>J</sub> = 125 °C		-	58	-				
Dook recovery ourrent	ı	T <sub>J</sub> = 25 °C	I <sub>F</sub> = 20 A dI <sub>F</sub> /dt = 1000 A/μs V <sub>B</sub> = 400 V	=	19	-	А			
Peak recovery current	I <sub>RRM</sub>	T <sub>J</sub> = 125 °C		=	32	-				
Develope vecesion, charge	0	T <sub>J</sub> = 25 °C		=	419	-	nC			
Reverse recovery charge	Q <sub>rr</sub>	T <sub>J</sub> = 125 °C		=	1176	-				
Dovorno rocovena timo	+	T <sub>J</sub> = 25 °C		=	46	-	ns A nC			
Reverse recovery time	t <sub>rr</sub>	T <sub>J</sub> = 125 °C		=	65	-				
Dools recovery overent		T <sub>J</sub> = 25 °C	I <sub>F</sub> = 30 A dI <sub>F</sub> /dt = 1000 A/µs	-	21	-				
Peak recovery current	I <sub>RRM</sub>	T <sub>J</sub> = 125 °C	$V_{\rm R} = 400 \text{ V}$	-	36	-				
Develope receiver above	0	T <sub>J</sub> = 25 °C		-	550	-				
Reverse recovery charge	Q <sub>rr</sub>	T <sub>J</sub> = 125 °C		-	1560	-				

THERMAL - MECHANICAL SPECIFICATIONS										
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS				
Thermal resistance, junction-to-case	R <sub>thJC</sub>		-	-	1.3	°C/W				
Weight			-	2.0	-	g				
Mounting torque			6.0 (5.0)	-	12 (10)	kgf · cm (lbf · in)				
Maximum junction and storage temperature range	T <sub>J</sub> , T <sub>Stg</sub>		-55	-	175	°C				
Marking device		Case style TO-220AC 2L	E5TH3006							

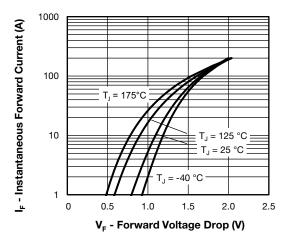


Fig. 1 - Forward Voltage Drop Characteristics, Per Leg

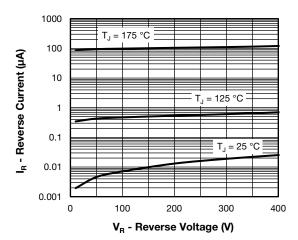


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage, Per Leg

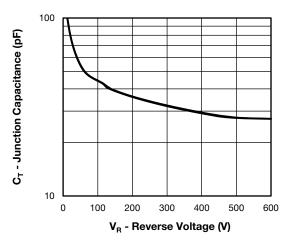


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage, Per Leg

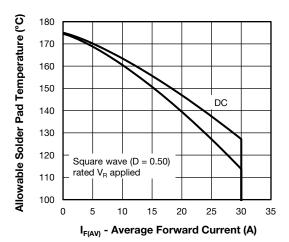


Fig. 4 - Maximum Allowable Case Temperature vs. Average Forward Current, Per Leg

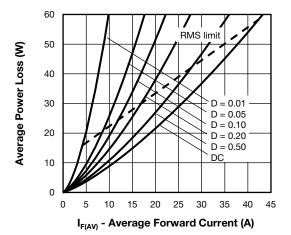


Fig. 5 - Forward Power Loss Characteristics, Per Leg

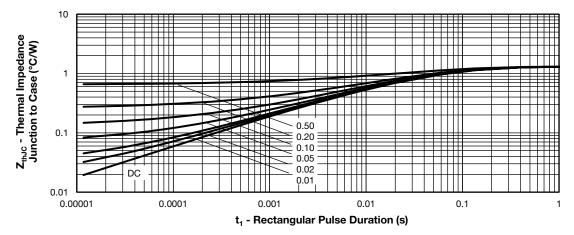


Fig. 6 - Transient Thermal Impedance, Junction to Case, Per Leg



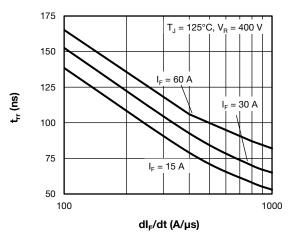


Fig. 7 - Typical Reverse Recovery Time vs. dl<sub>F</sub>/dt, Per Leg

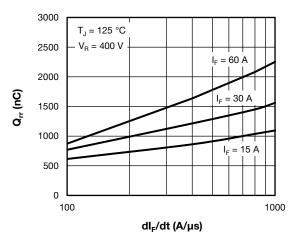


Fig. 8 - Typical Reverse Recovery Charge vs. dl<sub>F</sub>/dt, Per Leg

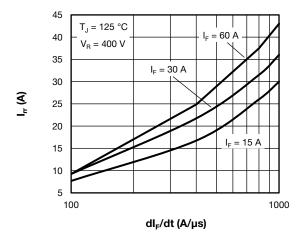


Fig. 9 - Typical Reverse Recovery Current vs.  $dI_F/dt$ , Per Leg

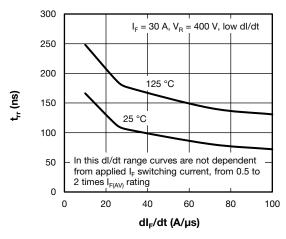


Fig. 10 - Typical Reverse Recovery Time vs. dl<sub>F</sub>/dt, Per Leg

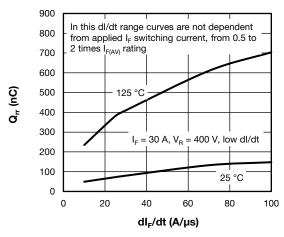


Fig. 11 - Typical Reverse Recovery Charge vs. dI<sub>F</sub>/dt, Per Leg

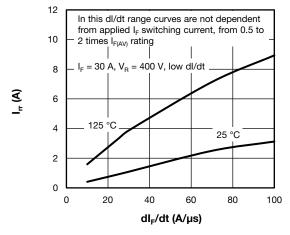


Fig. 12 - Typical Reverse Recovery Current vs.  $dI_F/dt$ , Per Leg

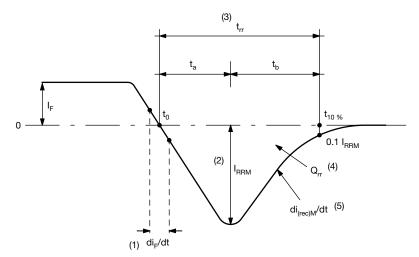


Fig. 13 - Reverse Recovery Waveform and Definitions

#### **Notes**

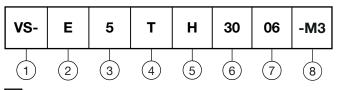
- (1) di<sub>F</sub>/dt rate of change of current through zero crossing
- (2) I<sub>RRM</sub> peak reverse recovery current
- (3) t<sub>rr</sub> reverse recovery time measured from t<sub>0</sub>, crossing point of negative going I<sub>F</sub>, to point t<sub>10%</sub>, 0.1 I<sub>RRM</sub>
- $^{(4)}$   $Q_{rr}$  area under curve defined by  $t_0$  and  $t_{10}$  %

$$Q_{rr} = \int_{t_0}^{t_{10}\%} I(t)dt$$

(5) di<sub>(rec)</sub>M/dt - peak rate of change of current during t<sub>b</sub> portion of t<sub>rr</sub>

#### **ORDERING INFORMATION TABLE**

**Device code** 



- Vishay Semiconductors product
- 2 E = single diode
- **3** 5 = FRED generation 5
- 4 Package: T = TO-220AC 2L
- 5 H = hyperfast recovery
- 6 Current rating (30 = 30 A)
- 7 Voltage rating (06 = 600 V)
- 8 Environmental digit:
  - -M3 = halogen-free, RoHS-compliant, and termination lead (Pb)-free

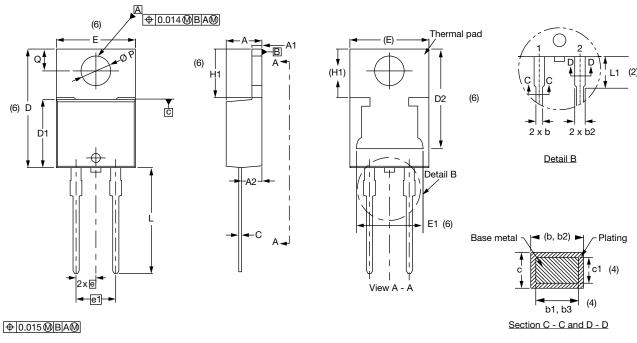
ORDERING INFORMATION (Example)									
PREFERRED P/N	BASE QUANTITY	PACKAGING DESCRIPTION							
VS-E5TH3006-M3	50	Antistatic plastic tube							

LINKS TO RELATED DOCUMENTS								
Dimensions <u>www.vishay.com/doc?96156</u>								
Part marking information	www.vishay.com/doc?95391							
SPICE model	www.vishay.com/doc?96919							



### **TO-220AC 2L**

#### **DIMENSIONS** in millimeters and inches



Lead tip

Conforms to JEDEC® outline TO-220AC

SYMBOL	MILLIMETERS		INCHES		NOTES	NOTES		MILLIN	IETERS	INC	HES	NOTES
STWIBUL	MIN.	MAX.	MIN.	MAX.	NOTES	NOTES	SYMBOL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	4.25	4.65	0.167	0.183			D2	11.68	13.30	0.460	0.524	6, 7
A1	1.14	1.40	0.045	0.055			E	10.11	10.51	0.398	0.414	3, 6
A2	2.50	2.92	0.098	0.115			E1	6.86	8.89	0.270	0.350	6
b	0.69	1.01	0.027	0.040			е	2.41	2.67	0.095	0.105	
b1	0.38	0.97	0.015	0.038	4		e1	4.88	5.28	0.192	0.208	
b2	1.20	1.73	0.047	0.068			H1	6.09	6.48	0.240	0.255	6
b3	1.14	1.73	0.045	0.068	4		L	13.52	14.02	0.532	0.552	
С	0.36	0.61	0.014	0.024			L1	3.32	3.82	0.131	0.150	2
с1	0.36	0.56	0.014	0.022	4		ØΡ	3.54	3.91	0.139	0.154	
D	14.85	15.35	0.585	0.604	3		Q	2.60	3.00	0.102	0.118	
D1	8.38	9.02	0.330	0.355								

### Notes

- $^{(1)}$  Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Lead dimension and finish uncontrolled in L1
- (3) Dimension D, D1, and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- (4) Dimension b1, b3, and c1 apply to base metal only
- (5) Controlling dimensions: inches
- (6) Thermal pad contour optional within dimensions E, H1, D2, and E1
- (7) Outline conforms to JEDEC® TO-220, except D2



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